



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET

MCH3481 — Low Voltage Drive Switching Device Applications

Features

- ON-resistance $R_{DS(on)} = 80\text{m}\Omega$ (typ.)
- Halogen free compliance
- 1.2V drive
- Protection diode in

Specifications

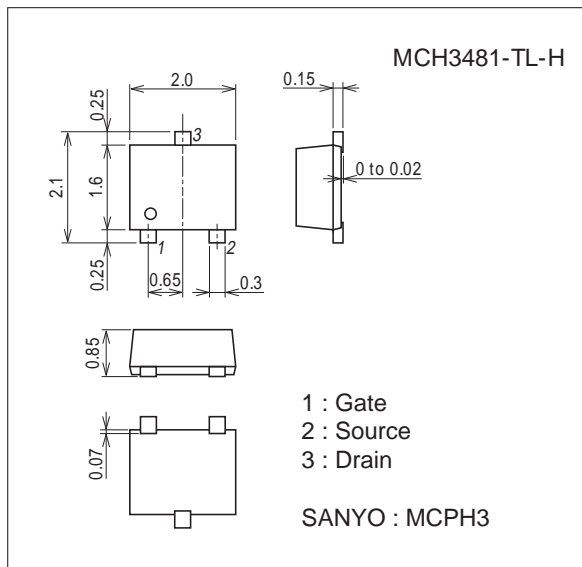
Absolute Maximum Ratings at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V_{DS}		20	V
Gate-to-Source Voltage	V_{GS}		± 9	V
Drain Current (DC)	I_D		2	A
Drain Current (Pulse)	I_{DP}	$PW \leq 10\mu\text{s}$, duty cycle $\leq 1\%$	8	A
Allowable Power Dissipation	P_D	When mounted on ceramic substrate ($900\text{mm}^2 \times 0.8\text{mm}$)	0.8	W
Channel Temperature	T_{ch}		150	$^\circ\text{C}$
Storage Temperature	T_{stg}		-55 to +150	$^\circ\text{C}$

Package Dimensions

unit : mm (typ)

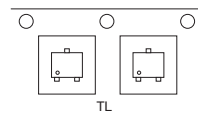
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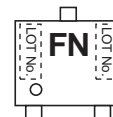
Product & Package Information

- Package : MCPH3
- JEITA, JEDEC : SC-70, SOT-323
- Minimum Packing Quantity : 3,000 pcs./reel

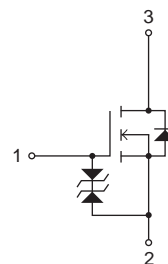
Packing Type : TL



Marking



Electrical Connection

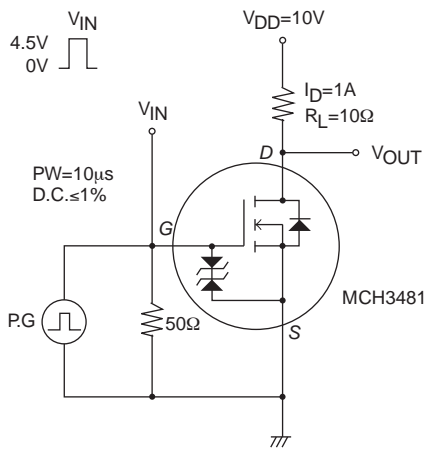


MCH3481

Electrical Characteristics at Ta=25°C

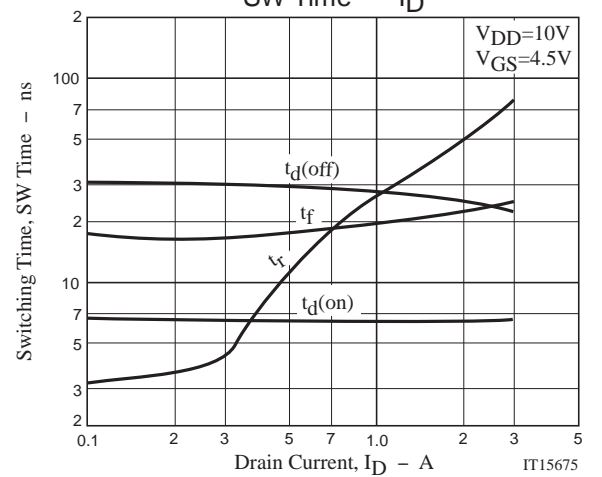
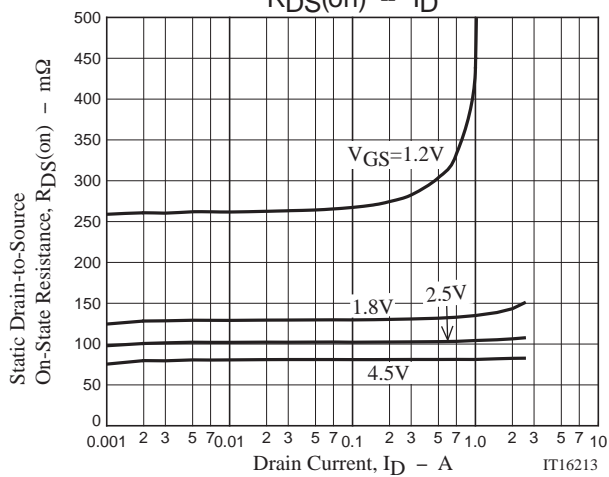
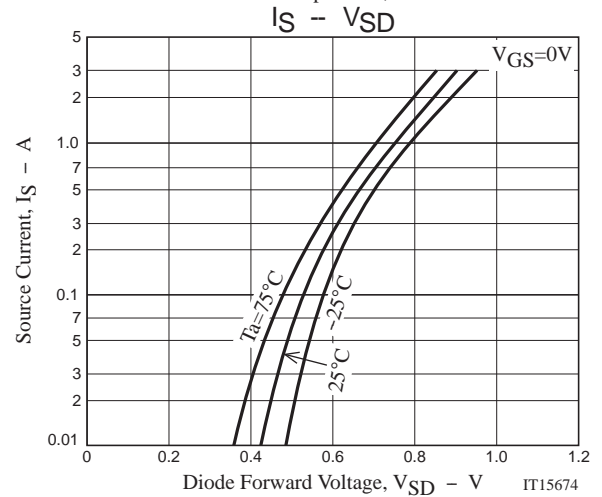
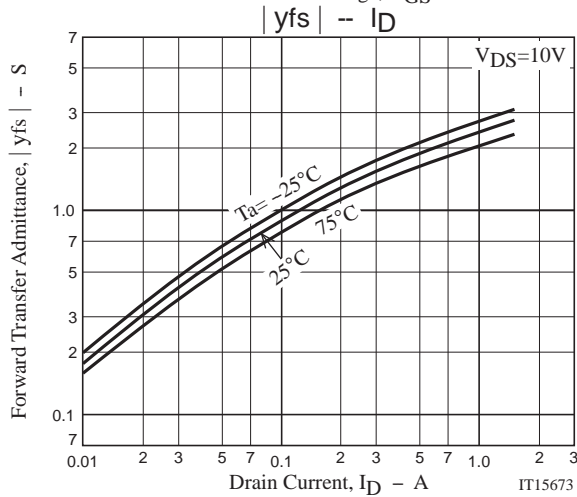
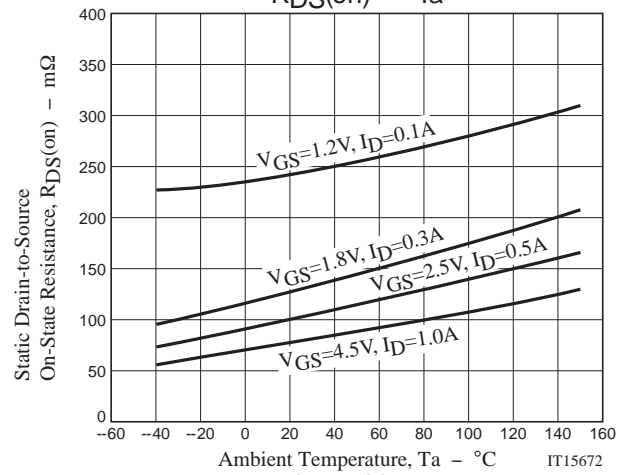
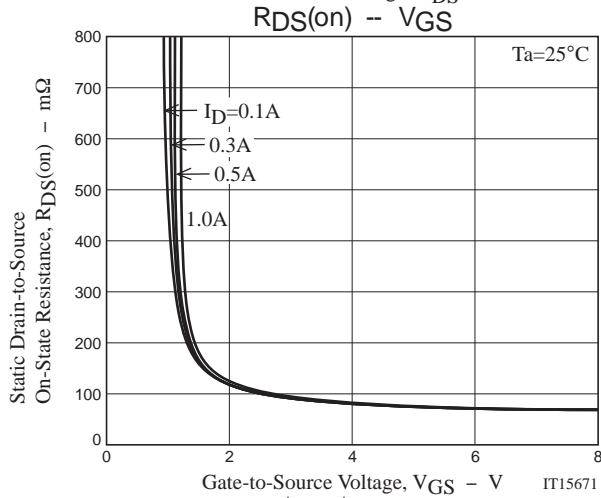
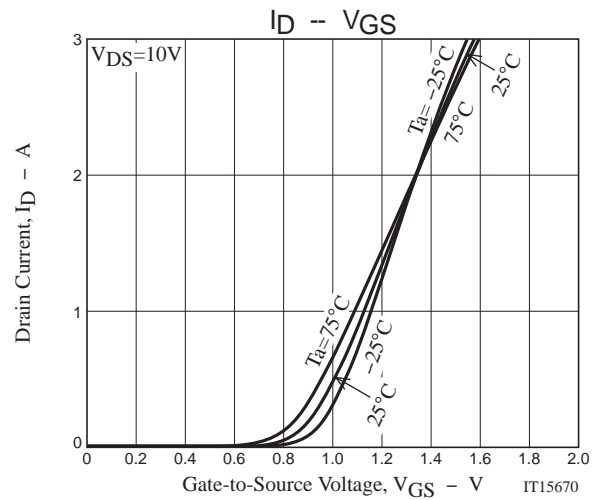
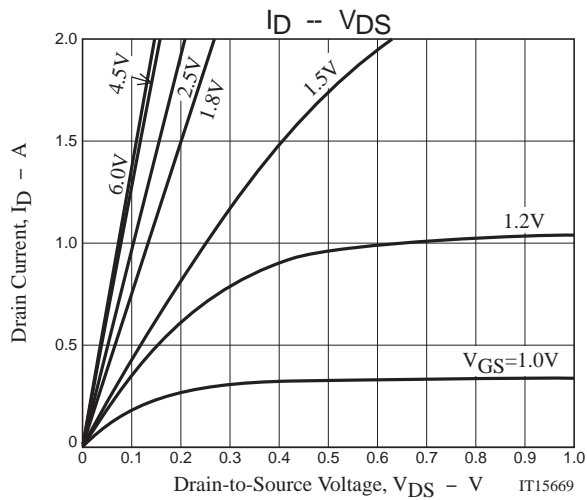
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D=1mA, V_{GS}=0V$	20			V
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS}=20V, V_{GS}=0V$			1	μA
Gate-to-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 7.2V, V_{DS}=0V$			± 10	μA
Cutoff Voltage	$V_{GS(off)}$	$V_{DS}=10V, I_D=1mA$	0.3		0.9	V
Forward Transfer Admittance	$ y_{fs} $	$V_{DS}=10V, I_D=1A$		2.4		S
Static Drain-to-Source On-State Resistance	$R_{DS(on)1}$	$I_D=1A, V_{GS}=4.5V$		80	104	$m\Omega$
	$R_{DS(on)2}$	$I_D=0.5A, V_{GS}=2.5V$		105	147	$m\Omega$
	$R_{DS(on)3}$	$I_D=0.3A, V_{GS}=1.8V$		135	203	$m\Omega$
	$R_{DS(on)4}$	$I_D=0.1A, V_{GS}=1.2V$		270	540	$m\Omega$
Input Capacitance	C_{iss}	$V_{DS}=10V, f=1MHz$		175		pF
Output Capacitance	C_{oss}			30		pF
Reverse Transfer Capacitance	C_{rss}			25		pF
Turn-ON Delay Time	$t_d(on)$	See specified Test Circuit.		6.6		ns
Rise Time	t_r			27		ns
Turn-OFF Delay Time	$t_d(off)$			28		ns
Fall Time	t_f			19		ns
Total Gate Charge	Q_g	$V_{DS}=10V, V_{GS}=4.5V, I_D=2A$		2.9		nC
Gate-to-Source Charge	Q_{gs}			0.46		nC
Gate-to-Drain "Miller" Charge	Q_{gd}			0.53		nC
Diode Forward Voltage	V_{SD}	$I_S=2A, V_{GS}=0V$		0.85	1.2	V

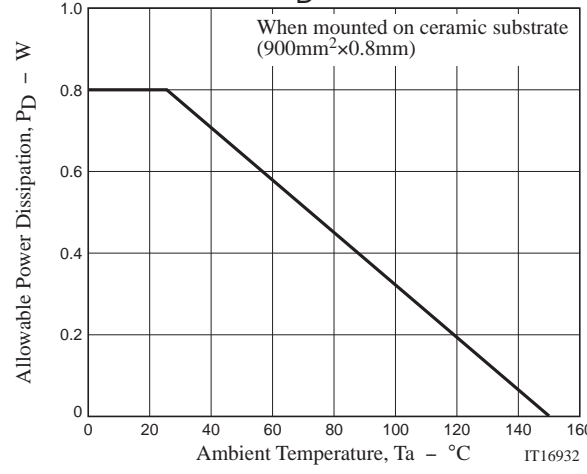
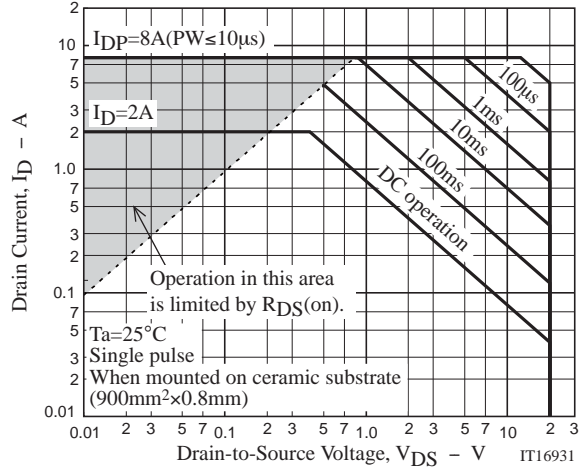
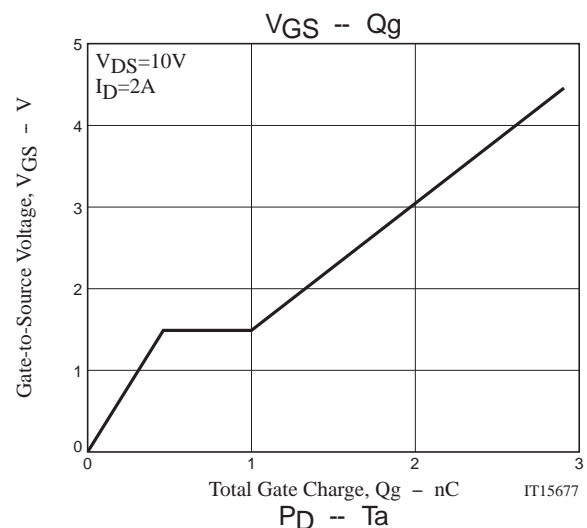
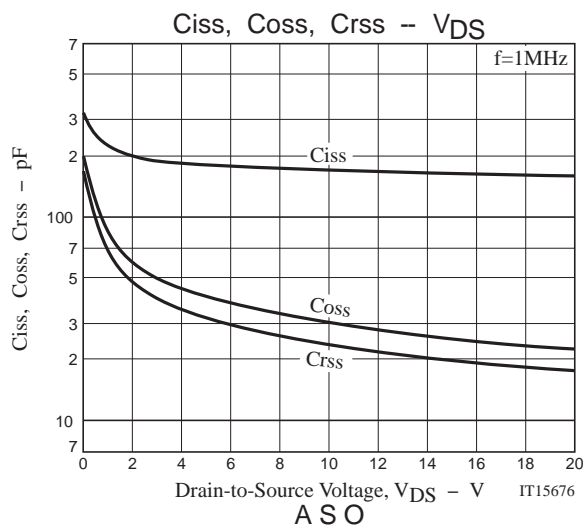
Switching Time Test Circuit



Ordering Information

Device	Package	Shipping	memo
MCH3481-TL-H	MCPH3	3,000pcs./reel	Pb Free and Halogen Free





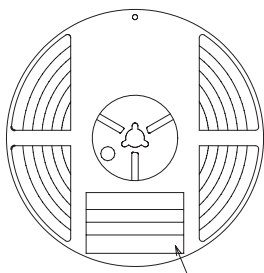
Taping Specification

MCH3481-TL-H

1. Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
MCPH3	MCPH3	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Packing method



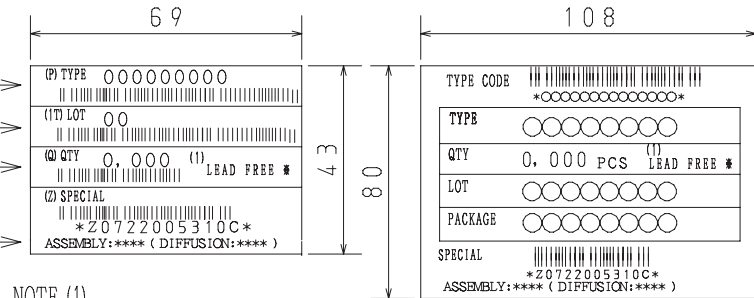
Type No.
LOT No.
Quantity
Origin

Reel label

Reel label, Inner box label
(unit:mm)

Outer box label

It is a label at the time of factory shipments.
The form of a label may change in physical
distribution process.



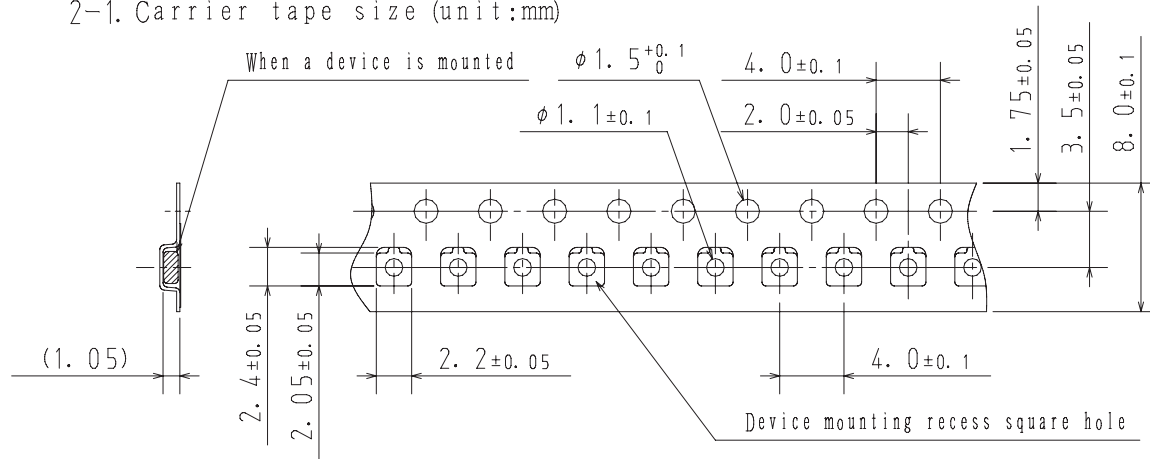
NOTE (1)

The LEAD FREE * description shows that the surface
treatment of the terminal is lead free.

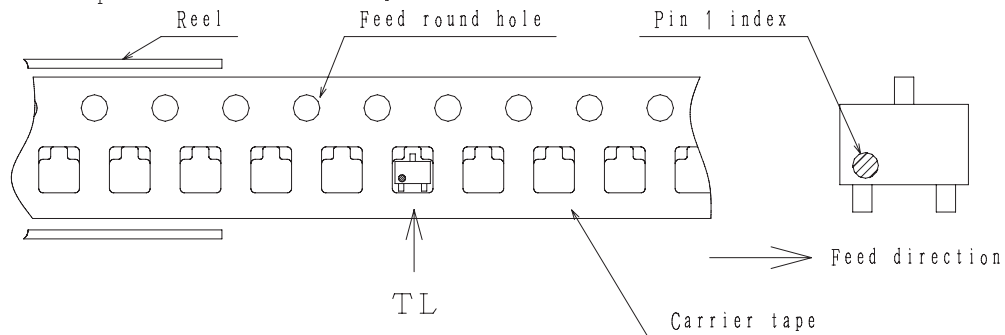
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)

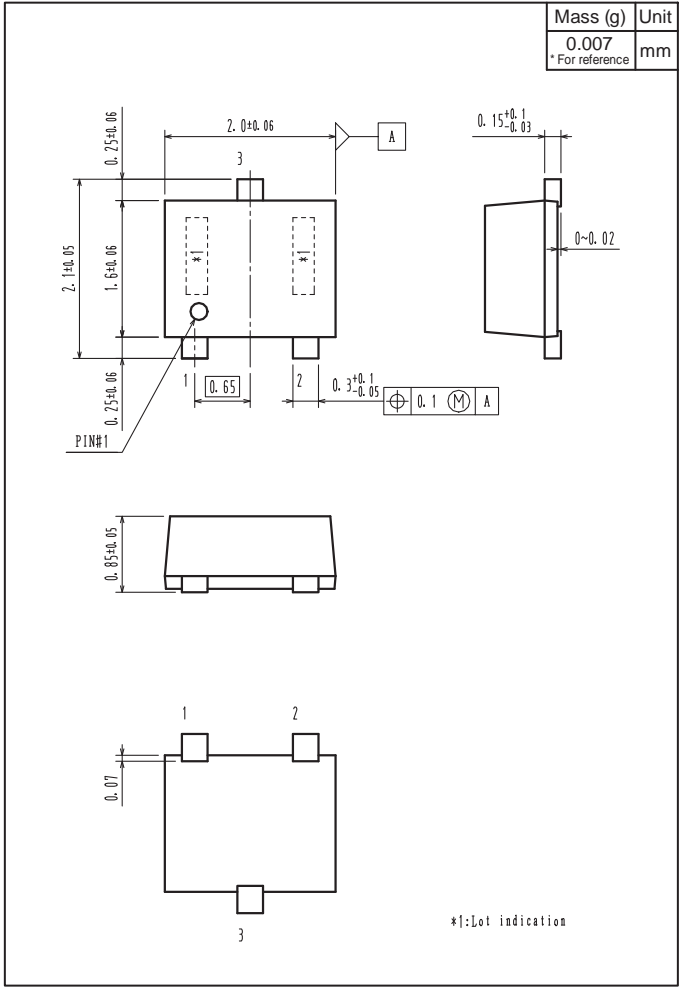


2-2. Device placement direction

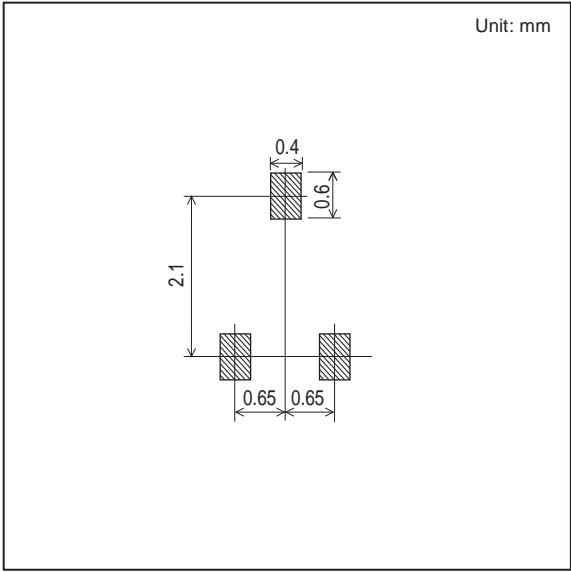


Those with pin 1 index on the feed hole side.....TL

Outline Drawing
MCH3481-TL-H



Land Pattern Example



Note on usage : Since the MCH3481 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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